

Information Disclosure Statement by Applicant	Docket Number CTS-2287	Application Number Herewith
	Inventor Langhorn	Examiner Name:
Page 1 of 1	Filing: 02/26/02	Group Art Unit:

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U.S. PATENT DOCUMENTS

[illegible]

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R. D. Baker

FOREIGN PATENT DOCUMENTS

Examiner Initial	Document Number	Date	Country	Class	SubClass	Translation
	Z-318632	11/13/95	Japan			x
	WO98/19349	08/27/97	PCT			

OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)

Hirokazu Iwata & Osamu Ishii "Conductive Adhesive-Free Surface Mount Type High Frequency Fundamental Crystal Resonators by Gold Bump Bonding" 1999 Joint Meeting EFTF-IEEE IFCS

Examiner <u>Shirley A. Jones</u>	Date Considered <u>5/17/03</u>
Examiner: Initial if citation considered, whether or not citation is in conformance with MPEP section 609; Draw line through citation if not in conformance and not considered. Included copy of this form with next communication to applicant.	

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